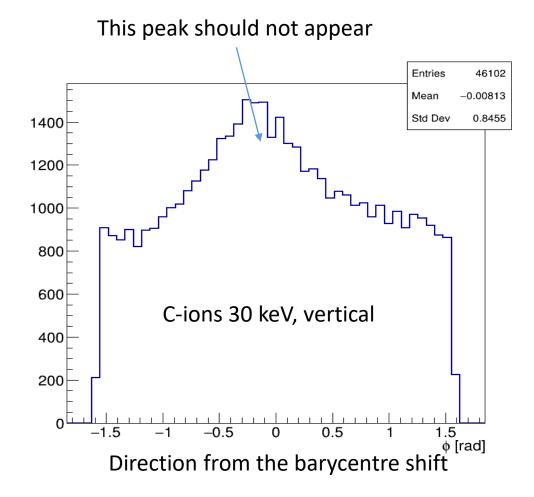
## Status of the microscope

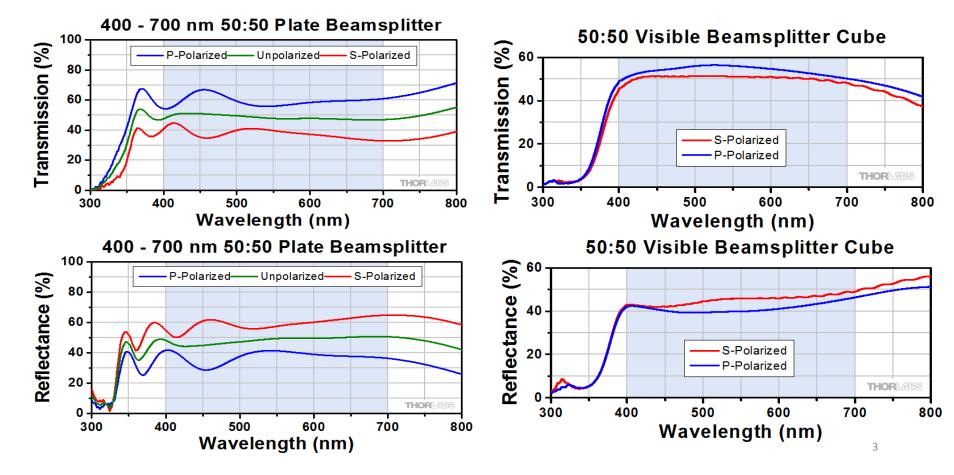
Andrey Alexandrov

#### Motivation





#### Beam-splitting cube (Thorlabs BS013)



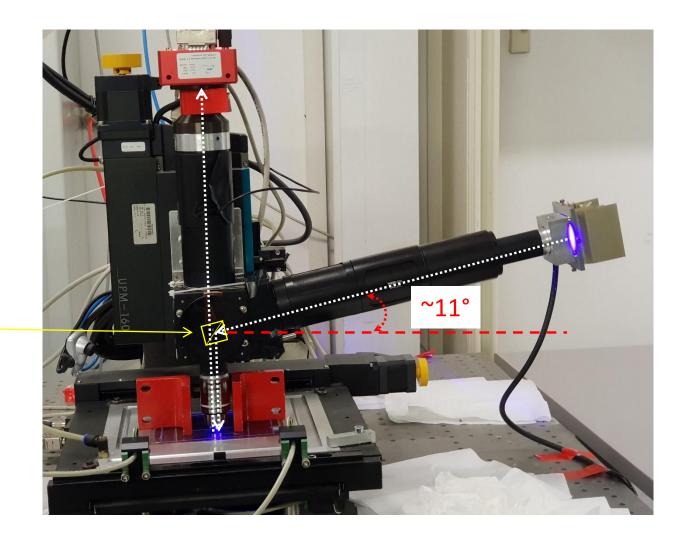
Beam-splitting plate

(Thorlabs BSW10R)

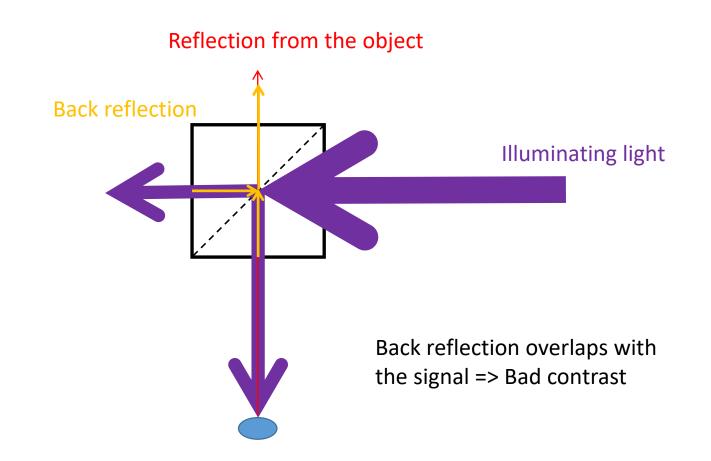
#### Upgraded microscope



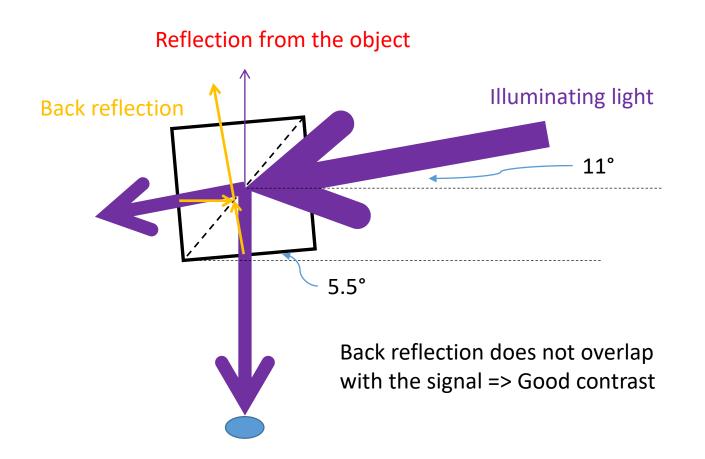
Beam-splitting cube (Thorlabs BS013)

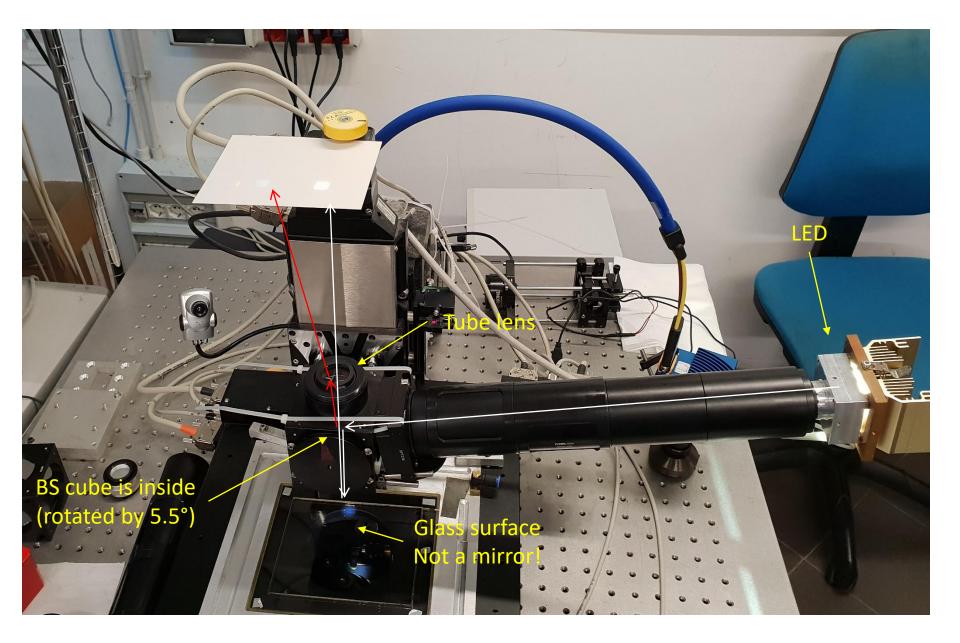


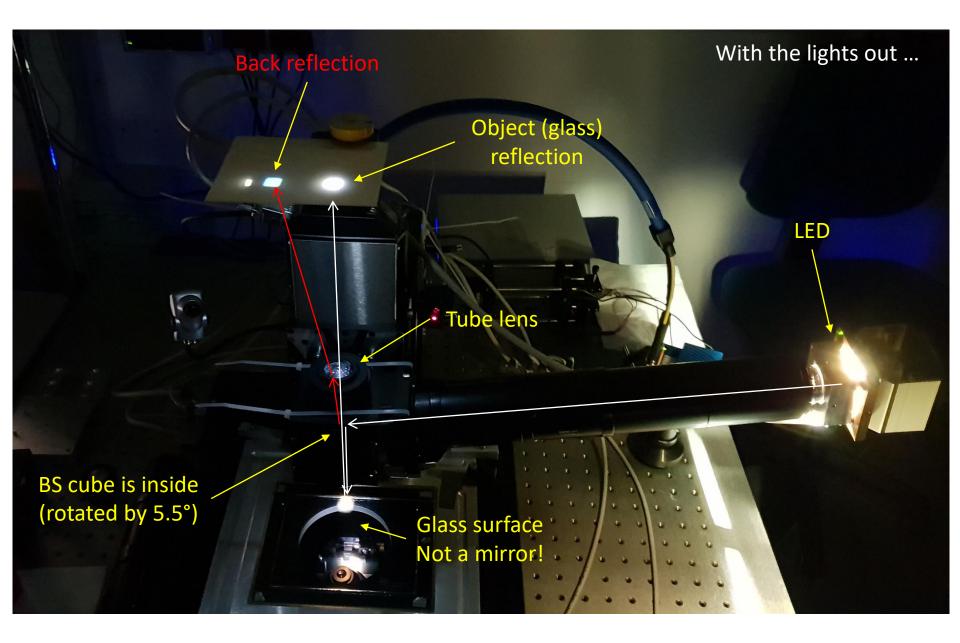
#### Direct BS mirror replacement



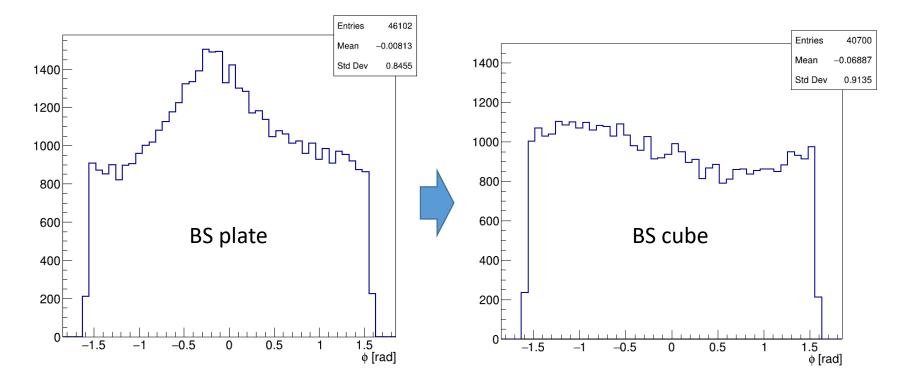
#### After BS cube rotation







#### Upgrade result (more details in Asada's and Valerio's talks)

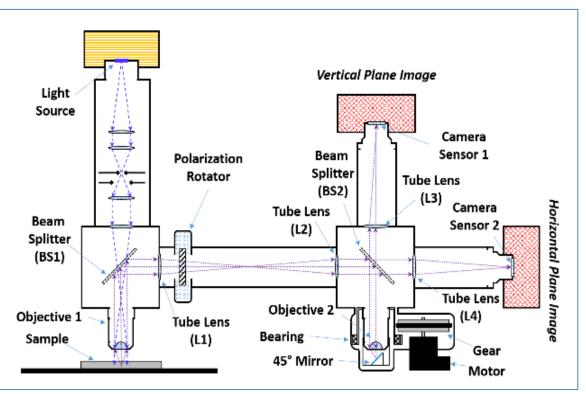


Direction from the barycentre shift

## 3D super-resolution microscope for color analysis

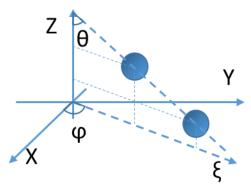
Andrey Alexandrov

#### 3D microscope

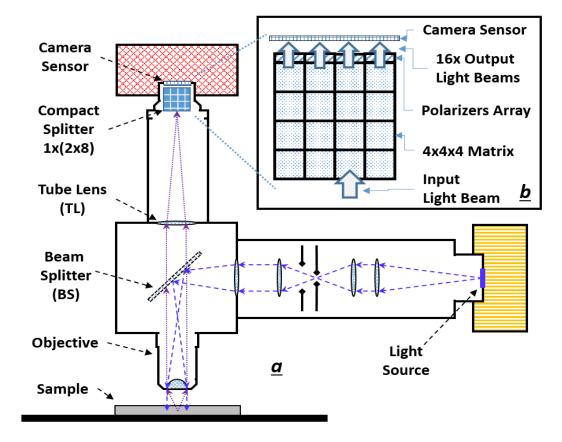


#### Weak Points:

- LC is not adapted for white light => no color analysis
- Slow LC operation => slow DAQ
- One image per polarization
  - Static position => slow DAQ
  - Sensitive to vibrations => Limited accuracy
- Two-phase measurement => slow DAQ

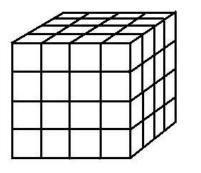


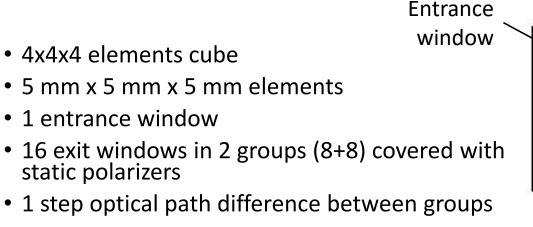
#### New 3D Super-Resolution Microscope

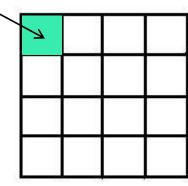


#### 8 polarizations × 2 focal planes with a single shot!

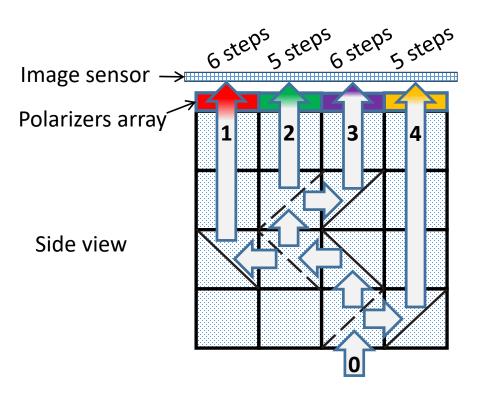
#### 16x compact splitter



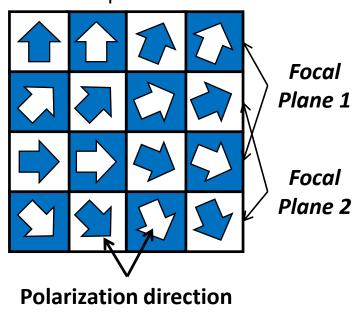




Bottom side



Top side



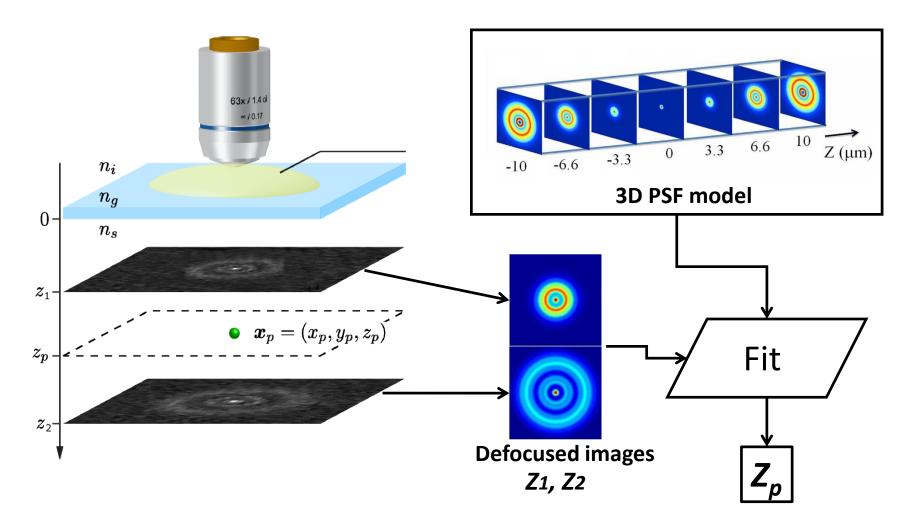
# Mikrotron EoSens 25CXP color camera

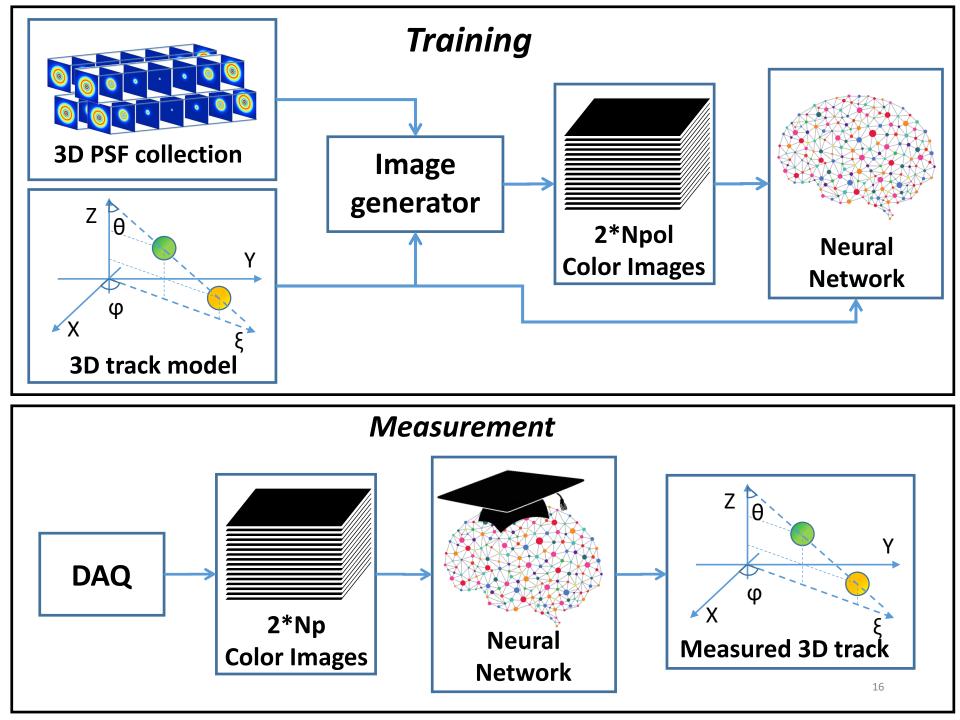




Resolution25 MpixActive pixels5,120 x 5,120 pxInterfaceCoaXPress® @ 4 x 6.25 Gbit/sFrame rate (8 bit)80 fpsSensorOnSemi PYTHON 25kSensor typeCMOS global shutterSensor format35 mm FFActive sensor area (H x V)23.04 x 23.04 mmPixel size4.5 x 4.5 µmSensitivity (mono)5.8 V/lux*s @ 550nmColor depth10 / 8 bitDynamic range59 dBShutter time (steps)1 µs - 0.1 sMax. Jitter±4 nsUIN 1.0 / DIN 2.3Mount optionF-MountDimensions (W x H x L w/o mount)80 x 80 x 66 mmWeight (w/o mount)540 gPower consumption12 WPower supply12 - 24 V DC 14		Eo <i>Sens®</i> 25CXP+ (monochrome / color)
InterfaceCoaXPress® @ 4 x 6.25 Gbit/sFrame rate (8 bit)80 fpsSensorOnSemi PYTHON 25kSensor typeCMOS global shutterSensor format35 mm FFActive sensor area (H x V)23.04 x 23.04 mmPixel size4.5 x 4.5 µmSensitivity (mono)5.8 V/lux*s @ 550nmColor depth10 / 8 bitDynamic range59 dBShutter time (steps)1 µsShutter time range1 µs - 0.1 sMax. Jitter±4 nsInterface ConnectorDIN 1.0 / DIN 2.3Mount optionF-MountDimensions (W x H x L w/o mount)80 x 80 x 66 mmWeight (w/o mount)540 gPower consumption12 W	Resolution	25 Mpix
Frame rate (8 bit)80 fpsSensorOnSemi PYTHON 25kSensor typeCMOS global shutterSensor format35 mm FFActive sensor area (H × V)23.04 x 23.04 mmPixel size4.5 x 4.5 µmSensitivity (mono)5.8 V/lux*s @ 550nmColor depth10 / 8 bitDynamic range59 dBShutter time (steps)1 µsShutter time range1 µs - 0.1 sMax. Jitter±4 nsUIN 1.0 / DIN 2.3Mount optionF-MountDimensions (W × H × L w/o mount)80 × 80 × 66 mmWeight (w/o mount)540 gPower consumption12 W	Active pixels	5,120 x 5,120 px
SensorOnSemi PYTHON 25kSensor typeCMOS global shutterSensor format35 mm FFActive sensor area (H x V)23.04 x 23.04 mmPixel size4.5 x 4.5 µmSensitivity (mono)5.8 V/lux*s @ 550nmColor depth10 / 8 bitDynamic range59 dBShutter time (steps)1 µsShutter time range1 µs - 0.1 sMax. Jitter±4 nsInterface ConnectorDIN 1.0 / DIN 2.3Mount optionF-MountDimensions (W x H x L w/o mount)80 x 80 x 66 mmWeight (w/o mount)540 gPower consumption12 W	Interface	CoaXPress® @ 4 x 6.25 Gbit/s
Sensor typeCMOS global shutterSensor format35 mm FFActive sensor area (H x V)23.04 x 23.04 mmPixel size4.5 x 4.5 µmSensitivity (mono)5.8 V/lux*s @ 550nmColor depth10 / 8 bitDynamic range59 dBShutter time (steps)1 µsShutter time range1 µs - 0.1 sMax. Jitter±4 nsInterface ConnectorDIN 1.0 / DIN 2.3Mount optionF-MountDimensions (W x H x L w/o mount)80 x 80 x 66 mmWeight (w/o mount)540 gPower consumption12 W	Frame rate (8 bit)	80 fps
Sensor format35 mm FFActive sensor area (H x V)23.04 x 23.04 mmPixel size4.5 x 4.5 µmSensitivity (mono)5.8 V/lux*s @ 550nmColor depth10 / 8 bitDynamic range59 dBShutter time (steps)1 µsShutter time range1 µs - 0.1 sMax. Jitter±4 nsInterface ConnectorDIN 1.0 / DIN 2.3Mount optionF-MountDimensions (W x H x L w/o mount)80 x 80 x 66 mmWeight (w/o mount)540 gPower consumption12 W	Sensor	OnSemi PYTHON 25k
Active sensor area (H x V)23.04 x 23.04 mmPixel size4.5 x 4.5 µmSensitivity (mono)5.8 V/lux*s @ 550nmColor depth10 / 8 bitDynamic range59 dBShutter time (steps)1 µsShutter time range1 µs - 0.1 sMax. Jitter±4 nsInterface ConnectorDIN 1.0 / DIN 2.3Mount optionF-MountDimensions (W x H x L w/o mount)80 x 80 x 66 mmWeight (w/o mount)540 gPower consumption12 W	Sensor type	CMOS global shutter
Pixel size4.5 x 4.5 μmSensitivity (mono)5.8 V/lux*s @ 550nmColor depth10 / 8 bitDynamic range59 dBShutter time (steps)1 μsShutter time range1 μs - 0.1 sMax. Jitter±4 nsInterface ConnectorDimensions (W x H x L w/o mount)Weight (w/o mount)540 gPower consumption12 W	Sensor format	35 mm FF
Sensitivity (mono)5.8 V/lux*s @ 550nmColor depth10 / 8 bitDynamic range59 dBShutter time (steps)1 µsShutter time range1 µs - 0.1 sMax. Jitter±4 nsInterface ConnectorDIN 1.0 / DIN 2.3Mount optionF-MountDimensions (W x H x L w/o mount)80 x 80 x 66 mmWeight (w/o mount)540 gPower consumption12 W	Active sensor area (H x V)	23.04 x 23.04 mm
Color depth10 / 8 bitDynamic range59 dBShutter time (steps)1 µsShutter time range1 µs - 0.1 sMax. Jitter±4 nsInterface ConnectorDIN 1.0 / DIN 2.3Mount optionF-MountDimensions (W x H x L w/o mount)80 x 80 x 66 mmWeight (w/o mount)540 gPower consumption12 W	Pixel size	4.5 x 4.5 μm
Dynamic range59 dBShutter time (steps)1 µsShutter time range1 µs - 0.1 sMax. Jitter±4 nsInterface ConnectorDIN 1.0 / DIN 2.3Mount optionF-MountDimensions (W x H x L w/o mount)80 x 80 x 66 mmWeight (w/o mount)540 gPower consumption12 W	Sensitivity (mono)	5.8 V/lux*s @ 550nm
Shutter time (steps)   1 µs     Shutter time range   1 µs - 0.1 s     Max. Jitter   ±4 ns     Interface Connector   DIN 1.0 / DIN 2.3     Mount option   F-Mount     Dimensions (W x H x L w/o mount)   80 x 80 x 66 mm     Weight (w/o mount)   540 g     Power consumption   12 W	Color depth	10 / 8 bit
Shutter time range   1 µs - 0.1 s     Max. Jitter   ±4 ns     Interface Connector   DIN 1.0 / DIN 2.3     Mount option   F-Mount     Dimensions (W x H x L w/o mount)   80 x 80 x 66 mm     Weight (w/o mount)   540 g     Power consumption   12 W	Dynamic range	59 dB
Max. Jitter ±4 ns   Interface Connector DIN 1.0 / DIN 2.3   Mount option F-Mount   Dimensions (W x H x L w/o mount) 80 x 80 x 66 mm   Weight (w/o mount) 540 g   Power consumption 12 W	Shutter time (steps)	1 µs
Interface Connector   DIN 1.0 / DIN 2.3     Mount option   F-Mount     Dimensions   80 x 80 x 66 mm     (W x H x L w/o mount)   540 g     Power consumption   12 W	Shutter time range	1 µs – 0.1 s
Mount option F-Mount   Dimensions (W x H x L w/o mount) 80 x 80 x 66 mm   Weight (w/o mount) 540 g   Power consumption 12 W	Max. Jitter	±4 ns
Dimensions (W x H x L w/o mount) 80 x 80 x 66 mm   Weight (w/o mount) 540 g   Power consumption 12 W	Interface Connector	DIN 1.0 / DIN 2.3
(W x H x L w/o mount) 80 x 80 x 66 mm   Weight (w/o mount) 540 g   Power consumption 12 W	Mount option	F-Mount
Power consumption 12 W	-	80 x 80 x 66 mm
	Weight (w/o mount)	540 g
Power supply 12 - 24 V DC 14	Power consumption	12 W
	Power supply	12 - 24 V DC 14

#### Z-coordinate reconstruction Dual-plane method





### Advantages of the new 3D SR microscope

✓ Adapted for white light illumination -> color analysis
✓ Image synchronization by design
✓ Insensitive to vibrations -> better accuracy
✓ 3D+SR+color reconstruction in motion! -> faster DAQ
✓ Simple design -> cheaper